

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Application of:

Thomas N. Marieb et al.

U.S. Serial No: 09/739,929

Examiner: Hoang, Quoc D.

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Art Unit: 2818

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 INTERCONNECTIONS HAVING
 IMPROVED ELECTROMIGRATION
 CHARACTERISTICS AND METHODS
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FORMAL DRAWINGS SUBMISSION

Enclosed herewith for submission in the United States Patent and Trademark Office are six (6) sheets of formal drawings for the patent application referenced above.

If there are any further charges please charge them to Deposit Account No. 02-2666. A duplicate of this sheet is enclosed for that purpose.

Respectfully submitted,

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Dated: 2/28, 2002

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